

IXFK230N20T IXFX230N20T

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

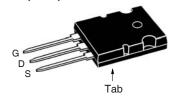


Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	$T_J = 25^{\circ}\text{C} \text{ to } 175^{\circ}\text{C}$	200	V	
V _{DGR}	$T_J = 25^{\circ}\text{C to } 175^{\circ}\text{C}, R_{GS} = 1M\Omega$	200		
V _{GSS}	Continuous	± 20	V	
V _{GSM}	Transient	± 30		
I _{D25} I _{L(RMS)}	$T_{c} = 25^{\circ}\text{C}$ (Chip Capability)	230	A	
	External Lead Current Limit	160	A	
	$T_{c} = 25^{\circ}\text{C}$, Pulse Width Limited by T_{JM}	630	A	
I _A	$T_{c} = 25^{\circ}C$	100	A	
E _{AS}	$T_{c} = 25^{\circ}C$	3	J	
dv/dt	$I_{_{S}}$ $\leq I_{_{DM}}, V_{_{DD}} \leq V_{_{DSS}}, T_{_{J}} \leq 175^{\circ}C$	20	V/ns	
P _D	T _C = 25°C	1670	W	
T _J T _{JM} T _{stg}		-55 +175 175 -55 +175	°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°	
T _L	1.6mm (0.062 in.) from Case for 10s	300	°C	
	Plastic Body for 10s	260	°C	
M _d	Mounting Torque (TO-264)	1.13/10	Nm/lb.in.	
F _c	Mounting Force (PLUS247)	20120 /4.527	N/lb.	
Weight	TO-264	10	g	
	PLUS247	6	g	

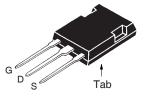
Symbol (T _J = 25°C U	Test Conditions Inless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max	
BV _{DSS}	$V_{GS} = 0V, I_{D} = 3mA$	200			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 8mA$	3.0		5.0	V
l _{gss}	$V_{GS} = \pm 20V$, $V_{DS} = 0V$			± 200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$, = 150°C		50 3	μA mA
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 60A, Note 1$			7.5	mΩ

 $V_{_{DSS}} = 200V$ $I_{_{D25}} = 230A$ $R_{_{DS(on)}} \le 7.5m\Omega$ $t_{_{rr}} \le 200ns$

TO-264 (IXFK)



PLUS247 (IXFX)



G = Gate D = DrainS = Source Tab = Drain

Features

- International Standard Packages
- High Current Handling Capability
- Fast Intrinsic Diode
- Avalanche Rated
- Low R_{DS(on)}

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- Synchronous Recification
- DC-DC Converters
- Battery Chargers
- Switched-Mode and Resonant-Mode Power Supplies
- DC Choppers
- AC Motor Drives
- Uninterruptible Power Supplies
- High Speed Power Switching Applications



		Cha Min.	aracteristic Values Typ. Max.			
g _{fs}		$V_{DS} = 10V, I_{D} = 60A, Note 1$	100	160	1110.511	S
C _{iss})			28		nF
Coss	}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		2540		pF
\mathbf{C}_{rss}	J			310		pF
t _{d(on)})			41		ns
t,		Resistive Switching Times		35		ns
t _{d(off)}		$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 100A$ $R_{G} = 1\Omega$ (External)		104		ns
t _f	J	G ,		29		ns
$\mathbf{Q}_{g(on)}$)			378		nC
Q_{gs}	}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		125		nC
\mathbf{Q}_{gd}	J			86		nC
R _{thJC}					0.09	°C/W
$\mathbf{R}_{\mathrm{thCS}}$				0.15		°C/W

Source-Drain Diode

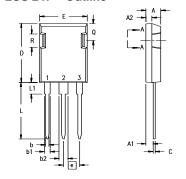
Symbo	ol Test Conditions	Characteristic Values				
$(T_J = 2)$	5°C, Unless Otherwise Specified)	Min.	Тур.	Max.		
Is	$V_{GS} = 0V$			230	Α	
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			920	Α	
V _{SD}	$I_F = 60A$, $V_{GS} = 0V$, Note 1			1.3	V	
t _{rr}	$I_F = 115A, -di/dt = 100A/\mu s$		0.74	200	ns μC	
I _{RM}	$V_{R} = 75V, V_{GS} = 0V$		10.6		Α	

Note 1: Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

TO-264 AA Outline To-264 AA Outline Terminals: 1 - Gate 2 - Drain 3 - Source 4 - Drain

Dim.	Millimeter		Inches		
	Min.	Max.	Min.	Max.	
Α	4.82	5.13	.190	.202	
Α1	2.54	2.89	.100	.114	
A2	2.00	2.10	.079	.083	
b	1.12	1.42	.044	.056	
b1	2.39	2.69	.094	.106	
b2	2.90	3.09	.114	.122	
С	0.53	0.83	.021	.033	
D	25.91	26.16	1.020	1.030	
E	19.81	19.96	.780	.786	
е	5.46 BSC		.215	BSC	
J	0.00	0.25	.000	.010	
K	0.00	0.25	.000	.010	
L	20.32	20.83	.800	.820	
L1	2.29	2.59	.090	.102	
Р	3.17	3.66	.125	.144	
Q	6.07	6.27	.239	.247	
Q1	8.38	8.69	.330	.342	
R	3.81	4.32	.150	.170	
R1	1.78	2.29	.070	.090	
S	6.04	6.30	.238	.248	
Т	1.57	1.83	.062	.072	

PLUS 247™ Outline



Terminals: 1 - Gate 2 - Drain 3 - Source

Dim.	Milli	meter	Inches		
	Min.	Max.	Min.	Max.	
Α	4.83	5.21	.190	.205	
A_1	2.29	2.54	.090	.100	
A ₂	1.91	2.16	.075	.085	
b	1.14	1.40	.045	.055	
b_1	1.91	2.13	.075	.084	
b_2	2.92	3.12	.115	.123	
С	0.61	0.80	.024	.031	
D	20.80	21.34	.819	.840	
E	15.75	16.13	.620	.635	
е	5.45	BSC	.215 BSC		
L	19.81	20.32	.780	.800	
L1	3.81	4.32	.150	.170	
Q	5.59	6.20	.220	0.244	
R	4.32	4.83	.170	.190	



Fig. 1. Output Characteristics @ $T_J = 25^{\circ}C$ 240 V_{GS} = 15V 10V 200 160 ID - Amperes 80 40 . 5V 0 0 0.2 0.4 0.6 0.8 1.2 1.4 1.6

V_{DS} - Volts

Fig. 2. Extended Output Characteristis @ T_J = 25°C

350

V_{GS} = 15V

10V

250

250

150

6V

100

50

0

1 2 3 4 5 6 7 8 9

V_{DS} - Volts

Fig. 3. Output Characteristics @ $T_J = 150^{\circ}C$ 240 V_{GS} = 15V 10V 8V 7V 200 ID - Amperes 120 80 5V 40 0 2.4 0 0.4 0.8 1.2 1.6 2.8 3.2 3.6 2

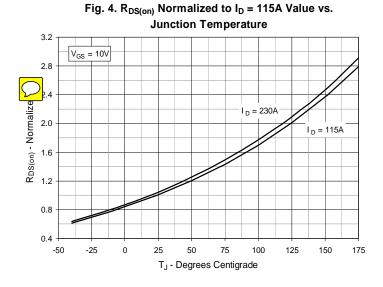
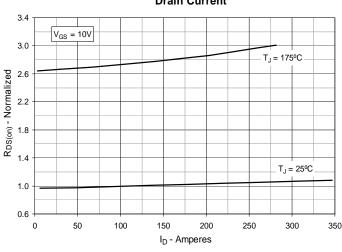
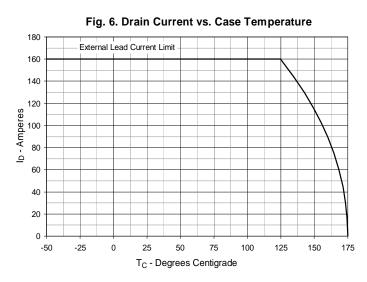


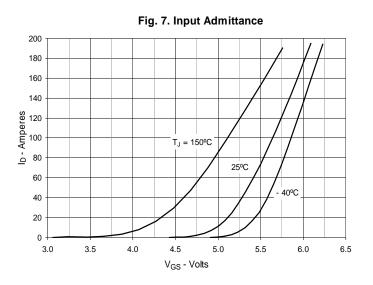
Fig. 5. $R_{DS(on)}$ Normalized to I_D = 115A Value vs. Drain Current





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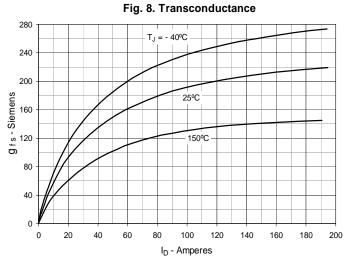
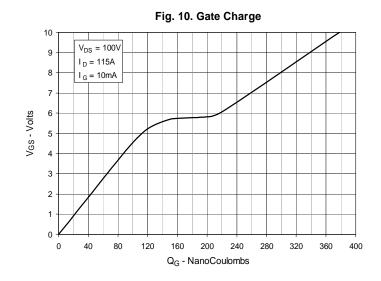
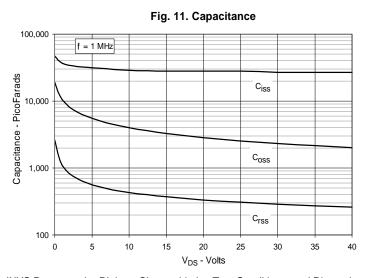
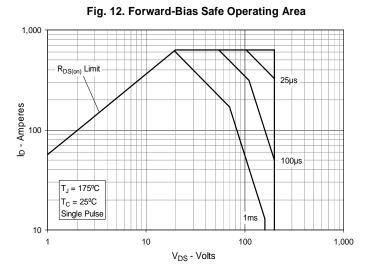


Fig. 9. Forward Voltage Drop of Intrinsic Diode 350 300 250 Is - Amperes 200 150 100 $T_{\rm J} = 150^{\rm o}{\rm C}$ $T_J = 25^{\circ}C$ 50 0 -0 0.2 0.4 0.8 1.2 1.4 0.6 V_{SD} - Volts







IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.



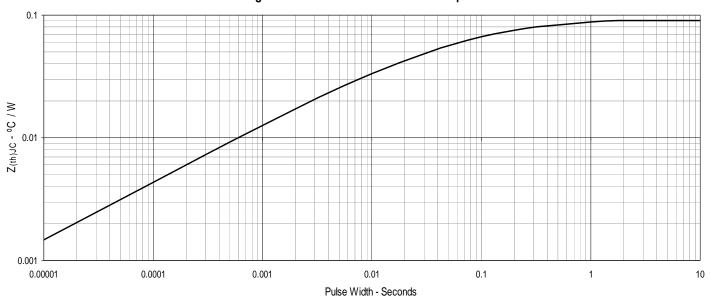


Fig. 13. Maximum Transient Thermal Impedance